

Vishay Siliconix

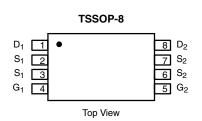
N- and P-Channel 30-V (D-S) MOSFET

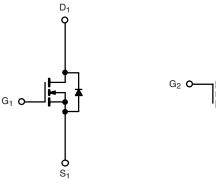
PRODUCT SUMMARY						
	V _{DS} (V)	R_{DS(on)} (Ω)	I _D (A)			
N-Channel	30	0.032 at V _{GS} = 10 V	4.3			
		0.046 at V _{GS} = 4.5 V	3.7			
P-Channel	- 30	0.043 at V _{GS} = - 10 V	- 3.8			
		0.073 at V _{GS} = - 4.5 V	- 2.8			

FEATURES

- Halogen-free
- TrenchFET[®] Power MOSFETS









 S_2

Ordering Information: Si6544BDQ-T1-GE3 (Lead (Pb)-free and Halogen-free)

N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS T_A = 25 °C, unless otherwise noted **N-Channel** P-Channel Parameter Symbol Unit 10 s **Steady State** 10 s **Steady State** Drain-Source Voltage V_{DS} - 30 30 ۷ Gate-Source Voltage V_{GS} ± 20 T_A = 25 °C - 3.8 - 3.8 4.3 3.7 Continuous Drain Current $(T_J = 150 \ ^{\circ}C)^a$ I_{D} T_A = 70 °C 3.5 - 3.0 3.0 - 2.6 А **Pulsed Drain Current** I_{DM} 20 - 20 Continuous Source Current (Diode Conduction)^a I_{S} 1.0 0.7 - 1.0 - 0.7 T_A = 25 °C 1.14 0.83 1.14 0.83 P_D W Maximum Power Dissipation^a T_A = 70 °C 0.73 0.53 0.73 0.53 T_J, T_{stg} Operating Junction and Storage Temperature Range - 55 to 150 °C

THERMAL RESISTANCE RATINGS									
Parameter		Symbol	Typical	Maximum	Unit				
Maximum langting to Anglianda	t ≤ 10 s	R _{thJA}	88	110					
Maximum Junction-to-Ambient ^a	Steady State		120	150	°C/W				
Maximum Junction-to-Foot (Drain)		R _{thJF}	65	80					

Notes:

a. Surface Mounted on FR4 board, $t \leq 10 \mbox{ s.}$

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Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit			
Static	•					•			
Gate Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	N-Ch	1.0		3.0	v		
		$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	P-Ch	- 1.0		- 3.0	v		
Gate-Body Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$	n-ch N-Ch			± 100 ± 100	nA		
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 30 V, V _{GS} = 0 V	P-Ch			1			
		V _{DS} = - 30 V, V _{GS} = 0 V	N-Ch			- 1			
		$V_{DS} = 30 V, V_{GS} = 0 V, T_{J} = 55 °C$	P-Ch			5	μA		
		$V_{DS} = -30 \text{ V}, \text{ V}_{GS} = 0 \text{ V}, \text{ T}_{J} = 55 \text{ °C}$	N-Ch			- 5			
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$	P-Ch	20			<u> </u>		
		$V_{DS} \ge -5 V$, $V_{GS} = -10 V$	N-Ch	- 20			A		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = 10 V, I _D = 4.3 A	P-Ch	0.025		0.032	+		
		V _{GS} = - 10 V, I _D = - 3.8 A	N-Ch		0.034	0.043	Ω		
		$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 3.7 \text{ A}$	P-Ch		0.037	0.046			
		$V_{GS} = -4.5 \text{ V}, \text{ I}_{D} = -2.8 \text{ A}$	N-Ch		0.058	0.073			
Forward Transconductance ^a	9 _{fs}	V _{DS} = 15 V, I _D = 4.3 A	P-Ch		11		S		
		V _{DS} = - 15 V, I _D = - 3.8 A	N-Ch		11				
	V _{SD}	I _S = 1.25 A, V _{GS} = 0 V	P-Ch		0.77	1.1	v		
Diode Forward Voltage ^a		I _S = - 1.25 A, V _{GS} = 0 V	N-Ch		- 0.77	- 1.1			
Dynamic ^b									
Total Gate Charge	Qg	N-Channel V _{DS} = 15 V, V _{GS} = 10 V, I _D = 4.3 A	N-Ch		9.5	15			
Total Gate Onlarge			P-Ch		16	25	_		
Gate-Source Charge	Q _{gs}		N-Ch		1.8		nC		
5	Q _{gd}	P-Channel	P-Ch N-Ch		2.3 1.55				
Gate-Drain Charge		$V_{DS} = -15 \text{ V}, V_{GS} = -10 \text{ V}, I_{D} = -3.8 \text{ A}$	P-Ch		4.5				
	_		N-Ch		0.45				
Gate Resistance	Rg		P-Ch		8.8		Ω		
Turn-On Delay Time	t _{d(on)}	N-Channel $V_{DD} = 15 V, R_1 = 15 \Omega$	N-Ch		13	25			
			P-Ch		14	25	4		
Rise Time	t _r	$V_{\text{DD}} = 13$ V, $H_{\text{L}} = 13$ M $I_{\text{D}} \cong 1$ A, $V_{\text{GEN}} = 10$ V, $R_{\text{G}} = 6$ Ω	N-Ch		14	25			
			P-Ch		14	25	-		
Turn-Off Delay Time	t _{d(off)}	P-Channel	N-Ch P-Ch		30 40	50 65	ns		
	t _f	$V_{DD} = -15 \text{ V}, \text{ R}_{L} = 15 \Omega$ $I_{D} \cong -1 \text{ A}, \text{ V}_{\text{GEN}} = -10 \text{ V}, \text{ R}_{\text{G}} = 6 \Omega$	N-Ch		40 10	20	-		
Fall Time		$D = -1$ A, $V_{GEN} = -10$ V, $T_G = 0.22$	P-Ch		30	50			
Source-Drain		I _F = 1.25 A, dl/dt = 100 A/μs	N-Ch		30	60	1		
Reverse Recovery Time		I _F = - 1.25 A, dl/dt = 100 A/μs	P-Ch		30				

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %. b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



4.5

30

N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

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20 20 V_{GS} = 10 thru 5 V 4 V 16 16 I D - Drain Current (A) I D - Drain Current (A) 12 12 8 8 T_C = 125 °C 4 4 25 3 V C 55 °C 0 0 2 3 0 1 4 5 0.0 0.5 1.0 1.5 2.0 2.5 3.0 3.5 4.0 V_{DS} - Drain-to-Source Voltage (V) V_{GS} - Gate-to-Source Voltage (V) **Transfer Characteristics Output Characteristics** 0.080 1100 0.064 C - Capacitance (pF) 880 $\mathsf{R}_{\mathsf{DS}(\mathsf{on})}$ - On-Resistance (Ω) Ciss 0.048 660 $V_{GS} = 4.5 V$ V_{GS} = 10 V 0.032 440 Coss 0.016 220 C_{rss} 0.000 0 0 4 8 12 16 20 0 6 12 18 24 I_D - Drain Current (A) V_{DS} - Drain-to-Source Voltage (V) **On-Resistance vs. Drain Current** Capacitance 1.6 10 $V_{GS} = 10 V$ $I_{D} = 4.3 A$ V_{DS} = 15 V I_D = 4.3 A V_{GS} - Gate-to-Source Voltage (V) 1.4 8 R_{DS(on)} - On-Resistance (Normalized) 6 1.2 1.0 4 2 0.8 0.6 0 2 - 50 - 25 0 25 50 75 100 125 150 0 4 6 8 10 Qg - Total Gate Charge (nC) T₁ - Junction Temperature (°C)

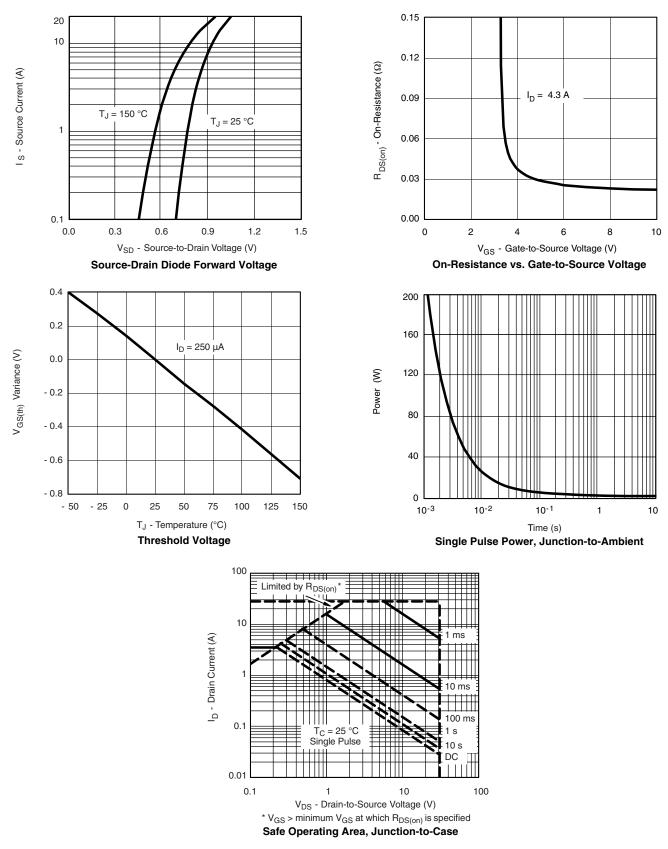
On-Resistance vs. Junction Temperature

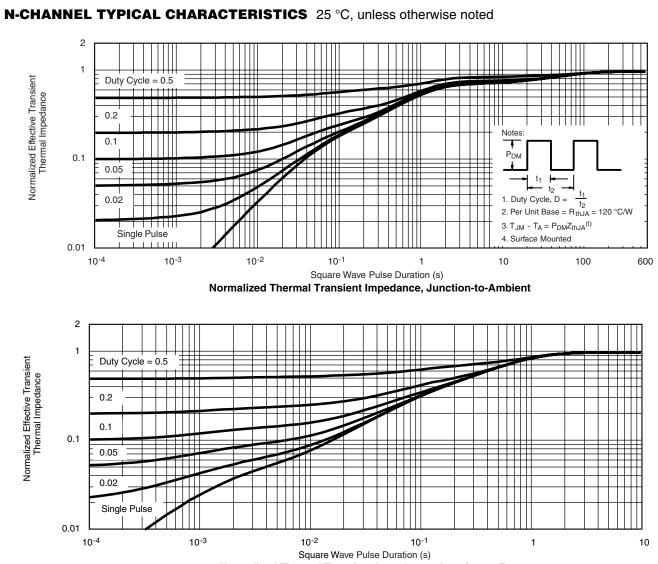
Gate Charge

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N-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





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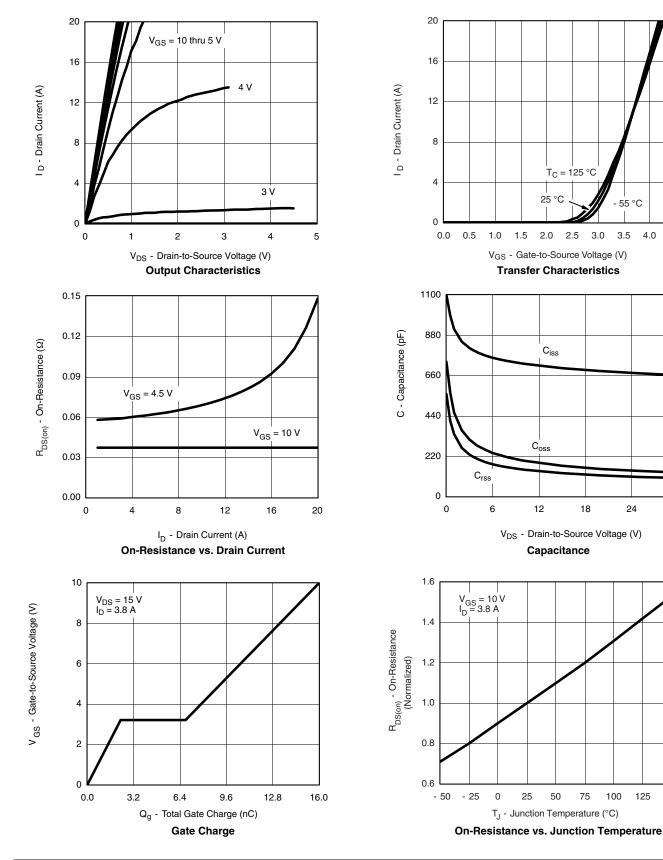
Normalized Thermal Transient Impedance, Junction-to-Foot

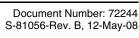
Si6544BDQ

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P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





100

125

150

75

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- 55 °C

2.5 3.0 3.5 4.0 4.5

18

24

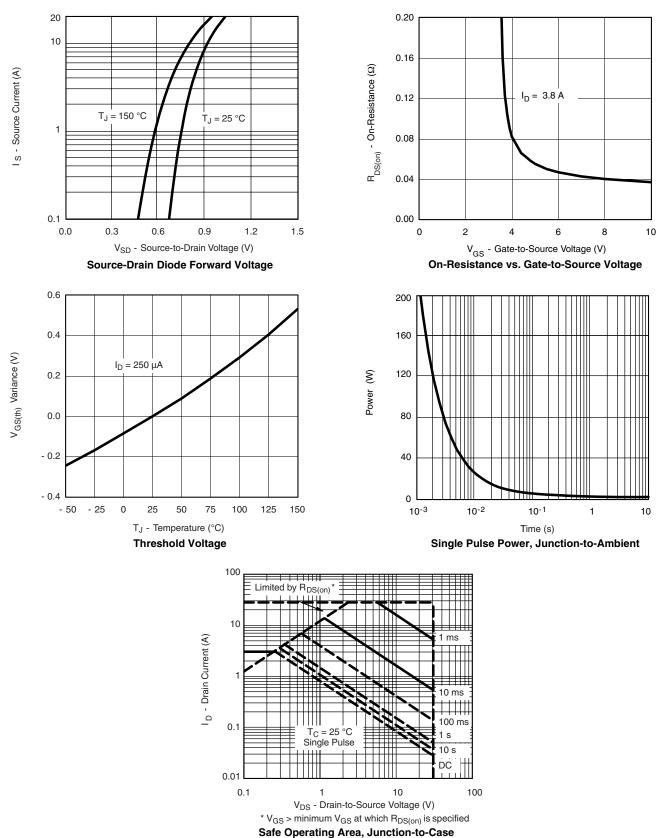
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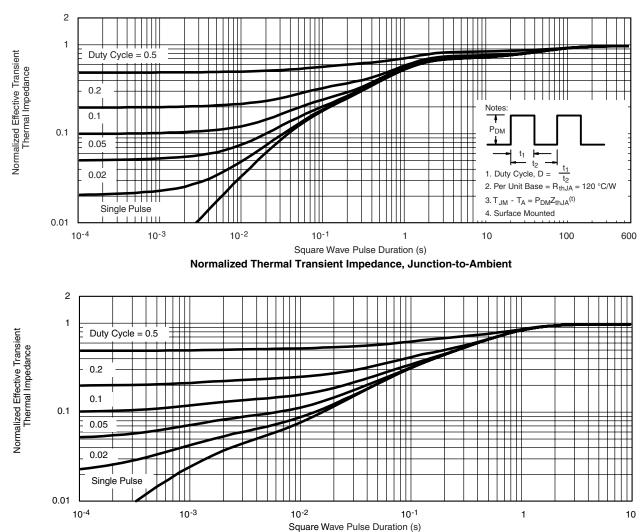


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P-CHANNEL TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

Normalized Thermal Transient Impedance, Junction-to-Foot

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see http://www.vishay.com/ppg?72244.

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